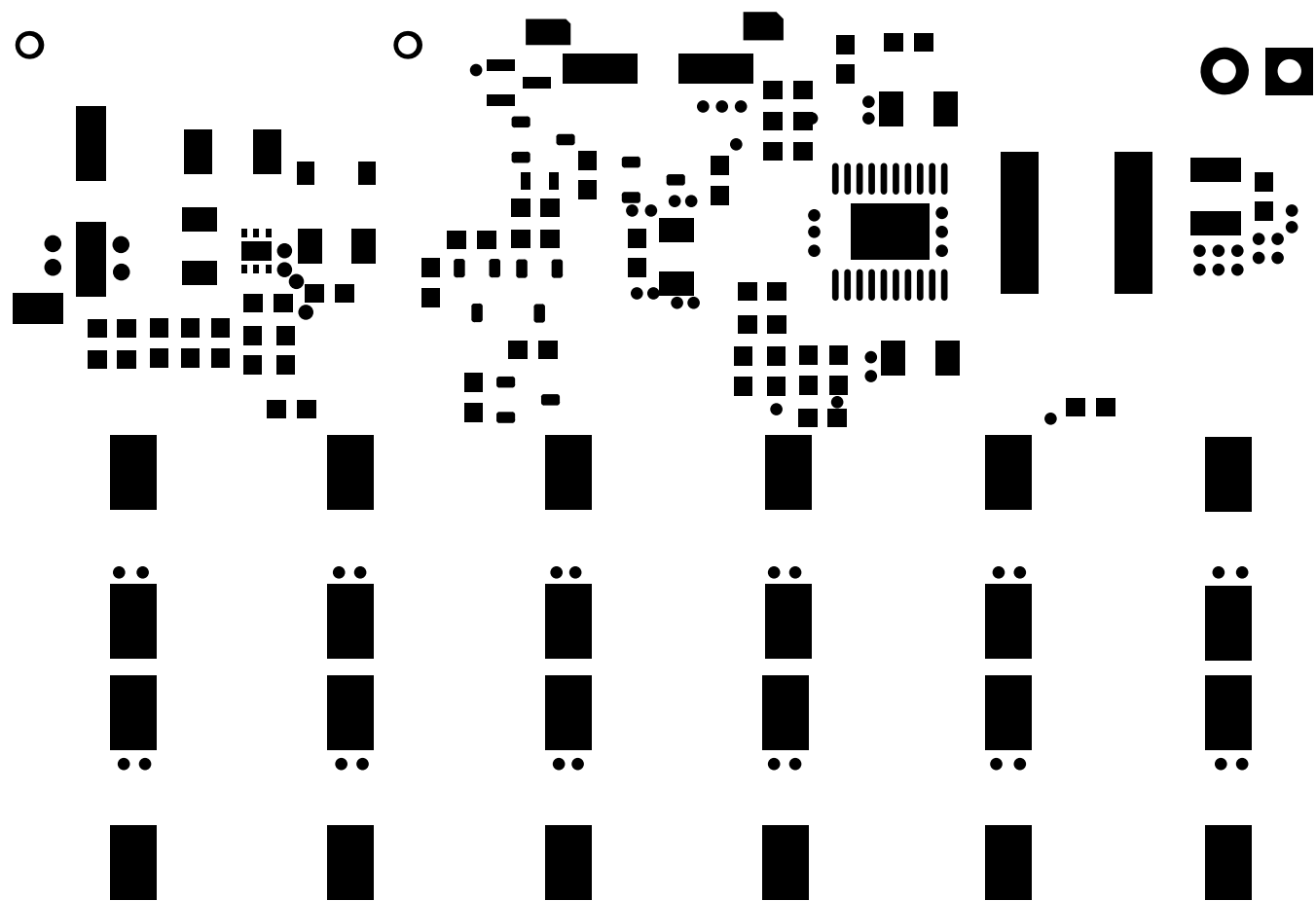
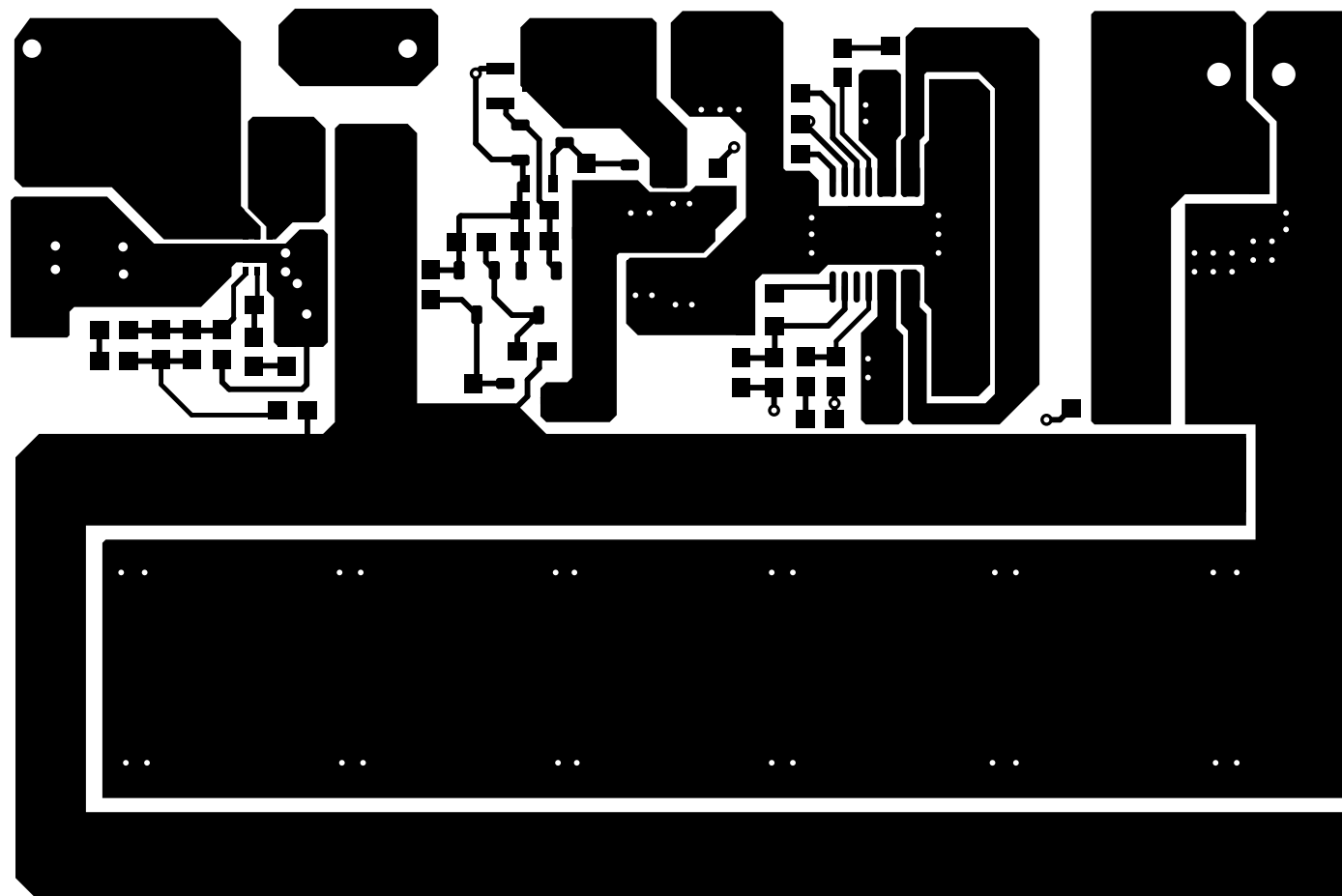


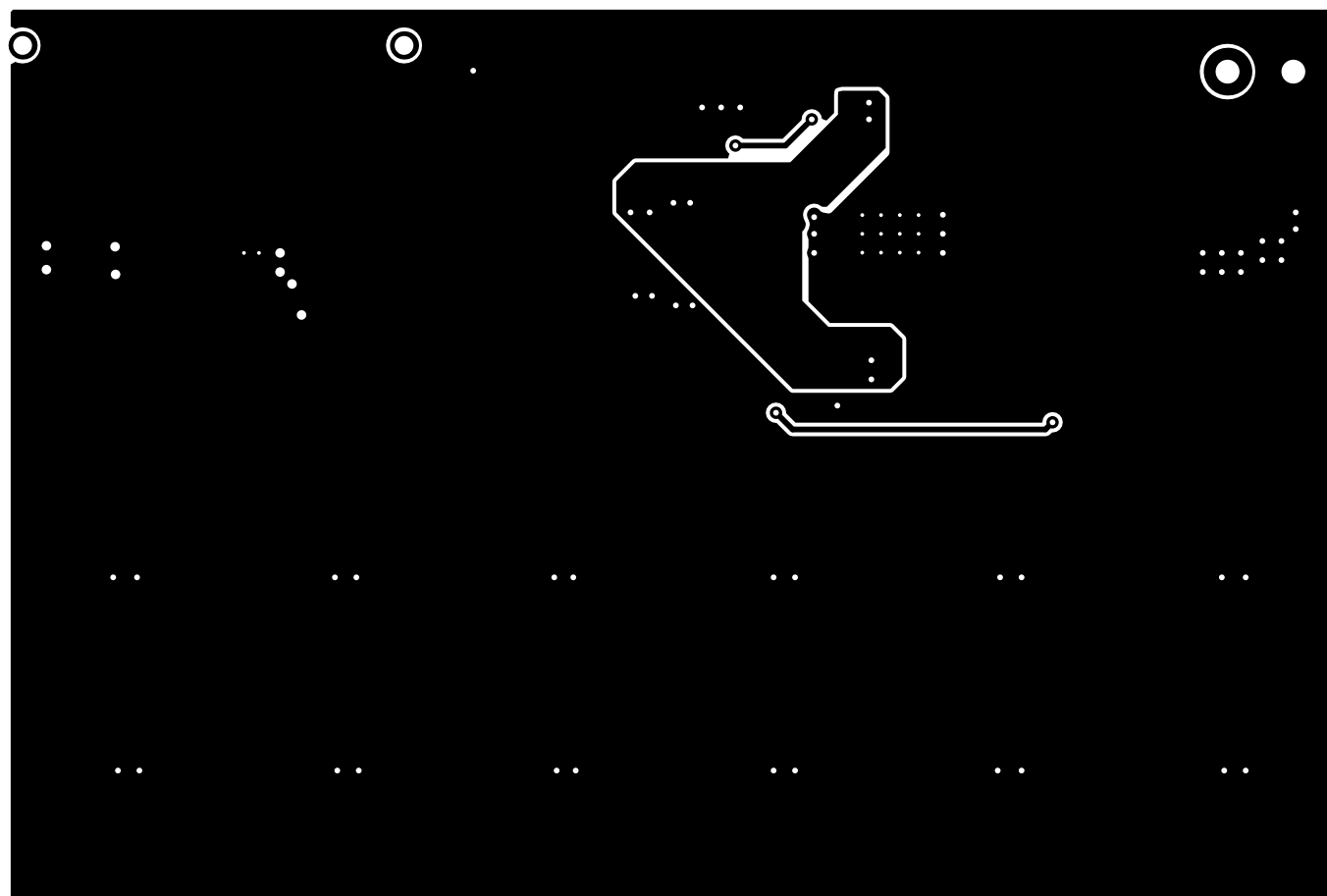
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP4494	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP4494		
PLOT NAME = Top Overlay	GENERATED : 8/1/2016	1:38:33 PM	TEXAS INSTRUMENTS



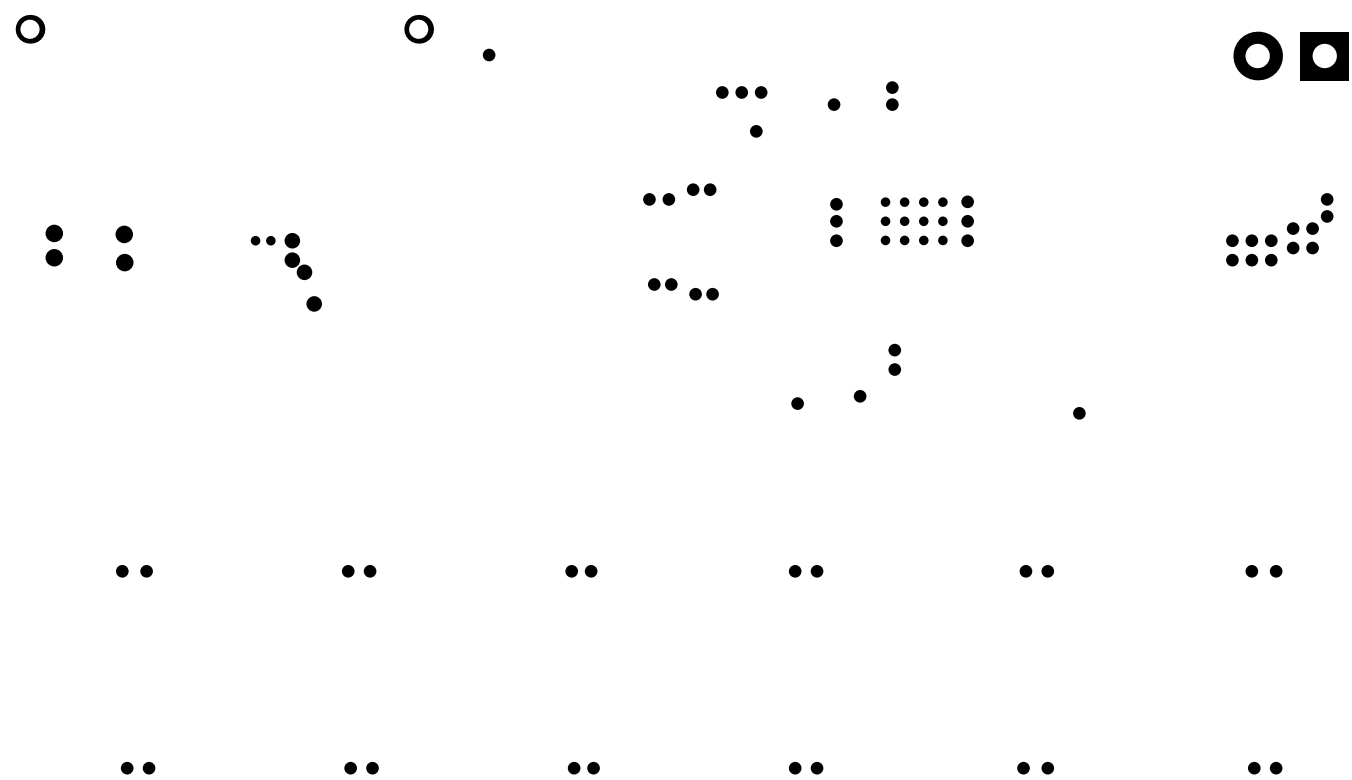
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP4494	REV: A	SVN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP4494		
PLOT NAME = Top Solder Mask	GENERATED : 8/1/2016	1:38:34 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP4494	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP4494		
PLOT NAME = Top Layer	GENERATED : 8/1/2016	1:38:35 PM	TEXAS INSTRUMENTS

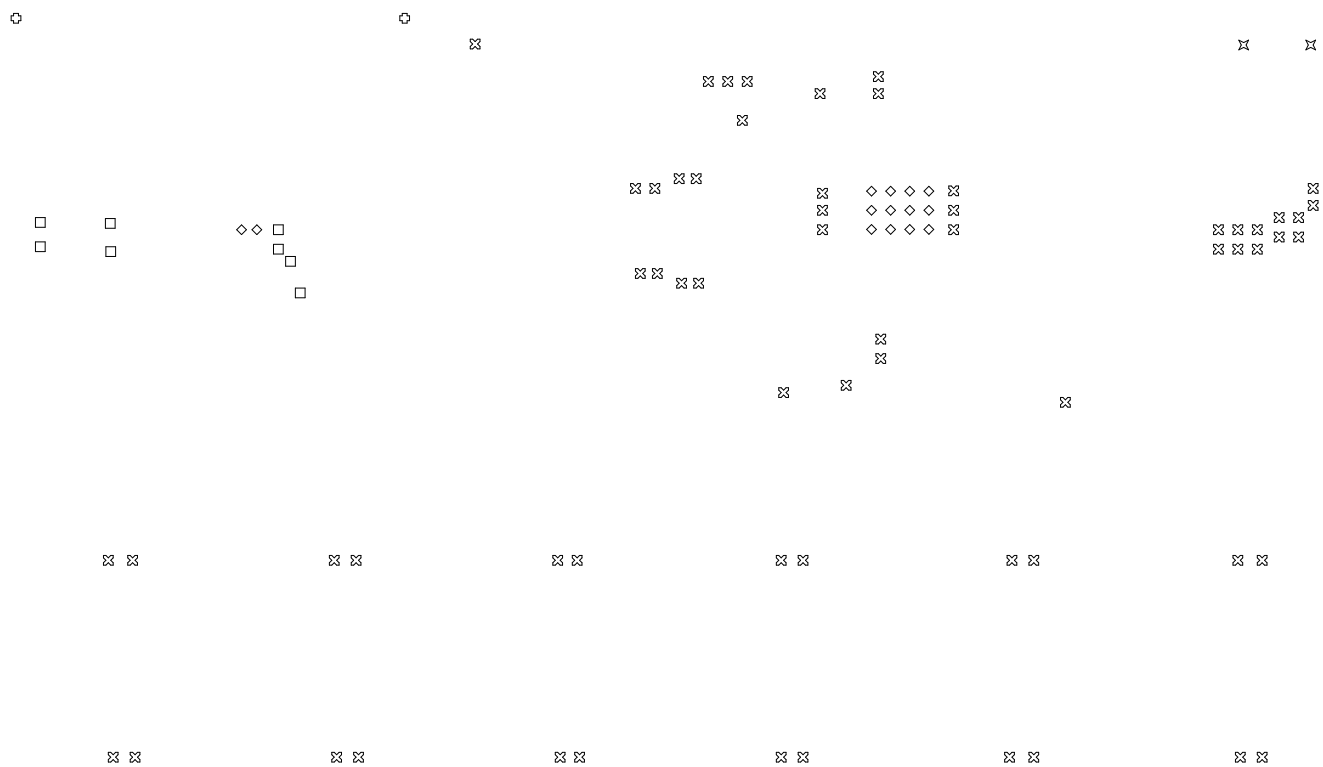


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP4494	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP4494		
PLOT NAME = Bottom Layer	GENERATED : 8/1/2016	1:38:36 PM	TEXAS INSTRUMENTS

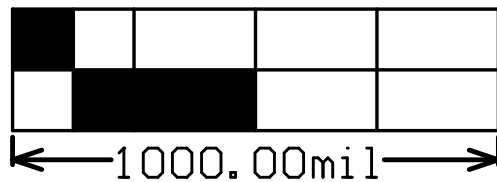


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP4494	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP4494		
PLOT NAME = Bottom Solder Mask	GENERATED : 8/1/2016	1:38:37 PM	TEXAS INSTRUMENTS

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP4494	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: PMP4494		
PLOT NAME = Bottom Overlay	GENERATED : 8/1/2016	1:38:38 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP4494	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP4494		
PLOT NAME = Drill Drawing	GENERATED : 8/1/2016	1:38:39 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP4494	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP4494		
PLOT NAME = Board Dimensions	GENERATED : 8/1/2016	1:38:40 PM	TEXAS INSTRUMENTS



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